

# Advanced Low Power 5V RS232 Drivers/Receivers with Small Capacitors

#### **FEATURES**

- ESD Protection over ±10kV
- Uses Small Capacitors: 0.1μF, 0.2μF
- 1µA Supply Current in SHUTDOWN
- Operates to 120k Baud
- CMOS Comparable Low Power
- Operates from a Single 5V Supply
- Easy PC Layout: Flowthrough Architecture
- Rugged Bipolar Design: Absolutely No Latch-Up
- Outputs Assume a High Impedance State When Off or Powered Down
- Improved Protection: RS232 I/O Lines Can be Forced to ±30V Without Damage
- Output Overvoltage Does Not Force Current Back Into Supplies
- Available in SO and SSOP Packages

#### DESCRIPTION

The LT1130A/LT1140A series of RS232 drivers/receivers features special bipolar construction techniques which protect the drivers and receivers beyond the fault conditions stipulated for RS232. Driver outputs and receiver inputs can be shorted to  $\pm 30V$  without damaging the device or the power supply generator. In addition, the RS232 I/O pins are resilient to multiple  $\pm 10kV$  ESD strikes. An advanced driver output stage operates up to 120kBaud while driving heavy capacitive loads. Supply current is typically 12mA, competitive with CMOS devices.

Several members of the series include flexible operating mode controls. The Driver Disable pin disables the drivers and the charge pump, the ON/OFF pin shuts down all circuitry. While shut down, the drivers and receivers assume high impedance output states.

#### **Basic Operation** LT1137A DRIVER IN DRIVER OUT BY OUT TO LOGIC BX OUT RX IN TO LINE -RX IN RX OUT RX IN **DRIVER IN** DRIVER OUT **RX OUT** 12 RX IN GND ON/OFF = 5V DRIVER DISABLE

LT1130A 5-Driver/5-Receiver RS232 Transceiver
LT1131A 5-Driver/4-Receiver RS232 Transceiver w/Shutdown
LT1132A 5-Driver/3-Receiver RS232 Transceiver
LT1133A 3-Driver/5-Receiver RS232 Transceiver
LT1134A 4-Driver/4-Receiver RS232 Transceiver
LT1135A 5-Driver/3-Receiver RS232 Transceiver w/o Charge Pump





LT1136A 4-Driver/5-Receiver RS232 Transceiver w/Shutdown LT1137A 3-Driver/5-Receiver RS232 Transceiver w/Shutdown LT1138A 5-Driver/3-Receiver RS232 Transceiver w/Shutdown LT1139A 4-Driver/4-Receiver RS232 Transceiver w/o Charge Pump LT1140A 5-Driver/3-Receiver RS232 Transceiver w/o Charge Pump LT1141A 3-Driver/5-Receiver RS232 Transceiver w/o Charge Pump

## **ABSOLUTE MAXIMUM RATINGS** (Note 1)

Supply Voltage (V <sub>CC</sub> )	6V	Short-Circuit Durat
V+	13.2V	٧+
V		V
Input Voltage		Driver Output
Driver	V <sup>-</sup> to V <sup>+</sup>	Receiver Output
Receiver		Operating Tempera
On/Off Pin	0.3V to 12V	LT113XAC/LT11
Driver Disable Pin	$-0.3V$ to $V_{CC} + 0.3V$	LT113XAIN/LT1
Output Voltage	<b>U</b> U	Storage Temperatu
Driver	30V to 30V	Lead Temperature
Receiver	$-0.3V$ to $V_{CC} + 0.3V$	·

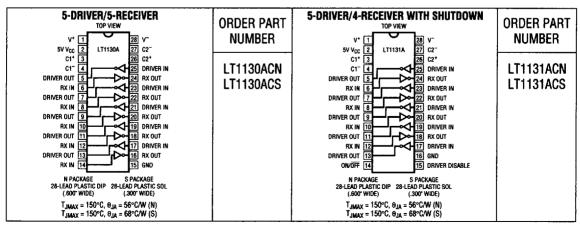
Short-Circuit Duration	
V+	30 sec
V <sup>-</sup>	30 sec
Driver Output	Indefinite
Receiver Output	Indefinite
Operating Temperature Range	
LT113XAC/LT114XAC	0°C to 70°C
LT113XAIN/LT114XAIS	40° to 85°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec).	300°C

#### PRODUCT SELECTION TABLE

Part Number	Power Supply Voltages*	Shutdown	Driver Disable	Drivers	Receivers	External Components
LT1130A	5	No	No	5	5	4 Capacitors
LT1131A	5	Yes	Yes	5	4	4 Capacitors
LT1132A	5	No	No	5	3	4 Capacitors
LT1133A	5	No	No	3	5	4 Capacitors
LT1134A	5	No	No	4	4	4 Capacitors
LT1135A	5, 12, -12	No	No	5	3	None
LT1136A	5	Yes	Yes	4	5	4 Capacitors
LT1137A	5	Yes	Yes	3	5	4 Capacitors
LT1138A	5	Yes	Yes	5	3	4 Capacitors
LT1139A	5, 12	Yes	No	4	4	2 Capacitors
LT1140A	5, 12, -12	Yes	Yes	5	3	None
LT1141A	5, 12, -12	Yes	Yes	3	5	None

<sup>\*</sup>The LT1130A, LT1131A, LT1132A, LT1134A, LT1136A, LT1137A and LT1138A can operate with 5V and 12V supplies and two external capacitors.

# PACKAGE/ORDER INFORMATION



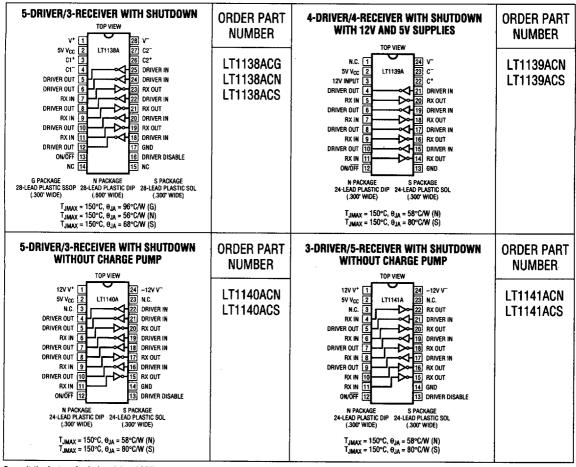


# PACKAGE/ORDER INFORMATION

5-DRIVER/3-RECEIVER	ORDER PART NUMBER	3-DRIVER/5-RECEIVER	ORDER PART NUMBER
V* 1 24 V 27 C2	LT1132ACN LT1132ACS	V 1 24 V 5V V CC 2 2 27 C2	LT1133ACN LT1133ACS
4-DRIVER/4-RECEIVER	ORDER PART NUMBER	5-DRIVER/3-RECEIVER WITHOUT CHARGE PUMP	ORDER PART NUMBER
V+ 1 24 V  5V V <sub>CC</sub> 2 LT1134A 23 C2  22 C2*  C1* 3 22 C2*  21 DRIVER IN  DRIVER OUT 5 38 RX OUT  RX IN 6 19 DRIVER IN  DRIVER OUT 7 17 DRIVER IN  DRIVER OUT 11 4 RX OUT  RX IN 10 10 14 RX OUT  RX IN 12 3 GND  N PACKAGE  24-LEAD PLASTIC OIP 24-LEAD PLASTIC SOL  (300° WIDE)  T <sub>JMAX</sub> = 150°C, 0 <sub>JA</sub> = 58°C/W (N)  T <sub>JMAX</sub> = 150°C, 0 <sub>JA</sub> = 58°C/W (S)	LT1134ACN LT1134ACS LT1134AIN LT1134AIS	TOP VIEW  12V V* 1	LT1135ACN LT1135ACS
4-DRIVER/5-RECEIVER WITH SHUTDOWN	ORDER PART NUMBER	3-DRIVER/5-RECEIVER WITH SHUTDOWN TOP VIEW V* 1 28 V-	ORDER PART NUMBER
1	LT1136ACN LT1136ACS	SV V <sub>CC</sub> 2 LT1137A 27 C2"  C1* 3	LT1137ACG LT1137ACN LT1137ACS LT1137AIN LT1137AIS
28-LEAD FLASTIC DIP 28-LEAD FLASTIC SOL (.600° WIDE) (.300° WIDE)  T_JMAX = 150°C, 0.JA = 56°C/W (N)  T_JMAX = 150°C, 0.JA = 68°C/W (S)		(300 WIDE) (300 WIDE) (300 WIDE)  TJIMAX = 150°C, θJA = 96°C/W (N)  TJIMAX = 150°C, θJA = 56°C/W (S)	



## PACKAGE/ORDER INFORMATION



Consult the factory for Industrial and Military parts

# **ELECTRICAL CHARACTERISTICS (Note 2)**

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS		
Power Supply Generator								
V+ Output				8.6		V		
V <sup>-</sup> Output				-7.8		v		
5V V <sub>CC</sub> Supply Current: LT1130A, LT1131A, LT1132A, LT1133A, LT1134A, LT1136A, LT1138A	(Note 3)	•		15	25	mA		
5V V <sub>CC</sub> Supply Current: LT1135A, LT1140A, LT1141A	(Note 3), V+ = 12V, V- = -12V	•		8	15	mA		
5V V <sub>CC</sub> Supply Current: LT1137A	(Note 3)	•		12	17	mA		
5V V <sub>CC</sub> Supply Current: LT1139A	(Note 3), V+ = 12V	•		8	15	mA		



# **ELECTRICAL CHARACTERISTICS** (Note 2)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
12V V+ Supply Current: LT1139A	(Note 3)	•		6	10	mA
-12V V - Supply Current: LT1135A, LT1140A, LT1141A	(Note 3) V+ = 12V	•		2	6	mA
Supply Current when OFF (V <sub>CC</sub> )	SHUTDOWN (Note 4) Driver Disable	•		1 4	10	μA mA
Supply Rise Time SHUTDOWN to Turn-On	C1, C2, C+, C <sup>-</sup> = 1.0μF C+, C <sup>-</sup> = 0.1μF, C1, C2 = 0.2μF			2.0 0.2		ms ms
ON/OFF Pin Thresholds	Input Low Level (Device SHUTDOWN) Input High Level (Device Enabled)	•	2.4	1.4 1.4	0.8	V V
ON/OFF Pin Current	0V ≤ V <sub>ON/OFF</sub> ≤ 5V	•	-15		80	μΑ
DRIVER DISABLE Pin Thresholds	Input Low Level (Drivers Enabled) Input High Level (Drivers Disabled)	•	2.4	1.4 1.4	0.8	V V
DRIVER DISABLE Pin Current	0V ≤ V <sub>DRIVER DISABLE</sub> ≤ 5V	•	-10		500	μΑ
Oscillator Frequency				130		kHz
Any Driver				~-		
Output Voltage Swing	Load = 3k to GND Positive Negative	•	5	7.3 -6.5	-5	V V
Logic Input Voltage Level	Input Low Level (V <sub>OUT</sub> = High) Input High Level (V <sub>OUT</sub> = Low)	•	2	1.4 1.4	8.0	V V
Logic Input Current	0.8V ≤ V <sub>IN</sub> ≤ 2V	•		5	20	μA
Output Short-Circuit Current	V <sub>OUT</sub> = 0V		±9	±17		mA
Output Leakage Current	SHUTDOWN V <sub>OUT</sub> = ±30V (Note 4)	•		10	100	μΑ
Slew Rate	$R_L = 3k$ , $C_L = 51pF$ $R_L = 3k$ , $C_L = 2500pF$			15 6	30	V/µs V/µs
Propagation Delay	Output Transition t <sub>HL</sub> High-to-Low (Note 5) Output Transition t <sub>LH</sub> Low-to-High			0.6 0.5	1.3 1.3	μs μs
Any Receiver						
Input Voltage Thresholds	Input Low Threshold (V <sub>OUT</sub> = High) Input High Threshold (V <sub>OUT</sub> = Low)	•	0.8	1.3 1.7	2.4	V V
Hysteresis		•	0.1	0.4	1	V
Input Resistance	V <sub>IN</sub> = ±10V		3	5	7	kΩ
Output Voltage	Output Low, $I_{OUT} = -1.6mA$ Output High, $I_{OUT} = 160\mu A$ ( $V_{CC} = 5V$ )	•	3.5	0.2 4.2	0.4	V
Output Leakage Current	SHUTDOWN (Note 4) 0 ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub>	•		1	10	μΔ
Output Short-Circuit Current	Sinking Current, V <sub>OUT</sub> = V <sub>CC</sub> Sourcing Current, V <sub>OUT</sub> = 0V		10	-20 20	-10	mA mA
Propagation Delay	Output Transition t <sub>HL</sub> High-to-Low (Note 6) Output Transition t <sub>LH</sub> Low-to-High			250 350	600 600	ns ns

The ullet denotes specifications which apply over the operating temperature range (0°C  $\leq$  T<sub>A</sub>  $\leq$  70°C for commercial grade and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C for industrial grade).

Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

**Note 2:** Testing done at  $V_{CC} = 5V$  and  $V_{ON/OFF} = 3V$ .

Note 3: Supply current is measured with driver and receiver outputs unloaded and the driver inputs tied high.

Note 4: Supply current and driver leakage current measurements in SHUTDOWN are performed with  $V_{ON/OFF} = 0.1V$ . Supply current measurements using DRIVER DISABLE are performed with  $V_{DRIVER DISABLE} = 3V$ .

For LT1135A, LT1139A, LT1140A and LT1141A with 12V supplies,  $V_{OUT}$  leakage is 200 $\mu$ A for  $V_{DUT}$  forced to  $\pm 25$ V.

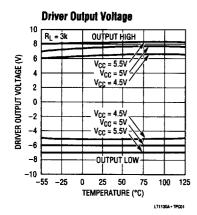
Note 5: For driver delay measurements,  $R_L=3k$  and  $C_L=51pF$ . Trigger points are set between the driver's input logic threshold and the output transition to the zero crossing ( $t_{HL}=1.4V$  to 0V and  $t_{LH}=1.4V$  to 0V).

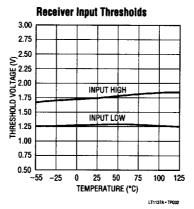
Note 6: For receiver delay measurements,  $C_L = 51 \, pF$ . Trigger points are set between the receiver's input logic threshold and the output transition to standard TTL/CMOS logic threshold ( $t_{HL} = 1.3 \, V$  to  $2.4 \, V$  and  $t_{LH} = 1.7 \, V$  to  $0.8 \, V$ ).

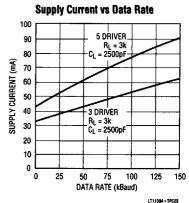
**Note 7:** For the LT1133A and LT1137A absolute maximum externally applied  $V^- = 6.5V$ . Internal charge pump will drive this pin to a higher negative voltage.

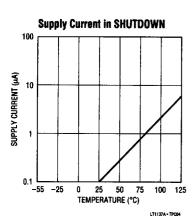


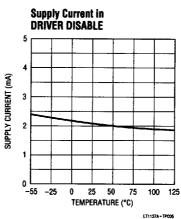
# TYPICAL PERFORMANCE CHARACTERISTICS

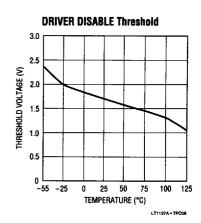


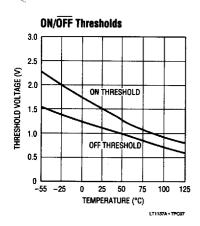


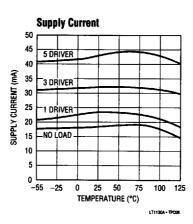


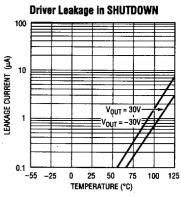








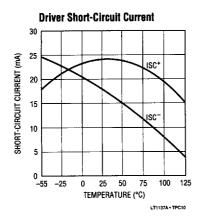


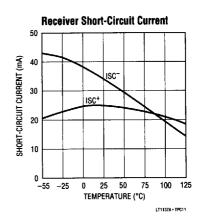


LT1137A • TPC09

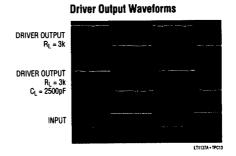


## TYPICAL PERFORMANCE CHARACTERISTICS





# DRIVER 10 OUTPUT HIGH RL = 3k 5 0 DRIVER 01 OUTPUT LOW RL = 3k -10 ON/OFF PIN



# PIN FUNCTIONS

 $V_{CC}$ : 5V Input Supply Pin. Supply current drops to zero in the SHUTDOWN mode. This pin should be decoupled with a  $0.1\mu F$  ceramic capacitor close to the package pin. Insufficient supply bypassing can result in low output drive levels and erratic charge pump operation.

GND: Ground Pin.

**ON/OFF:** Control the operation mode of the device and is TTL/CMOS compatible. A logic low puts the device in the SHUTDOWN mode which reduces input supply curent to zero and places all of the drivers and receivers in high impedance state. A logic high fully enables the transceiver.

**DRIVER DISABLE:** This pin provides an alternate control for the charge pump and RS232 drivers. A logic high on this pin shuts down the charge pump and places all drivers

in a high impedance state. Receivers remain active under these conditions. Floating the driver disable pin or driving it to a logic low level fully enables the transceiver. A logic low on the ON/OFF pin supersedes the state of the Driver Disable pin. Supply current drops to 4mA when in DRIVER DISABLE mode.

V\*: Positive Supply Output (RS232 Drivers). This pin requires an external charge storage capacitor  $C \geq 1.0 \mu F$ , tied to ground or  $V_{CC}$ . Larger value capacitors may be used to reduce supply ripple. With multiple transceivers, the V\* and V^ pins may be paralleled into common capacitors. For large numbers of transceivers, increasing the size of the shared common storage capacitors is recommended to reduce ripple.



LT1137A + TPC12

### PIN FUNCTIONS

V<sup>-</sup>: Negative Supply Output (RS232 Drivers). This pin requires an external charge storage capacitor  $C \ge 0.1 \mu F$ . V<sup>-</sup> is short-circuit proof for 30 seconds.

C1+, C1-, C2+, C2-: Commutating Capacitor Inputs. These pins require two external capacitors  $C \geq 0.2 \mu F$ : one from C1+ to C1-, and another from C2+ to C2-. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than  $2\Omega$ . For  $C \geq 1 \mu F$ , low ESR tantalum capacitors work well in this application, although small value ceramic capacitors may be used with a minimal reduction in charge pump compliance. In applications where larger positive voltages are available, such as 12V, C1 may be omitted and the positive voltage may be connected directly to the C1+ pin. In this mode of operation, the V+ pin should be decoupled with a  $0.1 \mu F$  ceramic capacitor.

**DRIVER IN:** RS232 Driver Input Pins. These inputs are TTL/CMOS compatible. Inputs should not be allowed to float. Tie unused inputs to  $V_{CC}$ .

**DRIVER OUT:** Driver Outputs at RS232 Voltage Levels. Driver output swing meets RS232 levels for loads up to 3k.

Slew rates are controlled for lightly loaded lines. Output current capability is sufficient for load conditions up to 2500pF. Outputs are in a high impedance state when in SHUTDOWN mode,  $V_{CC}=0V$ , or when the driver disable pin is active. Outputs are fully short-circuit protected from  $V^-+30V$  to  $V^+-30V$ . Applying higher voltages will not damage the device if the overdrive is moderately current limited. Short circuits on one output can load the power supply generator and may disrupt the signal levels of the other outputs. The driver outputs are protected against ESD to  $\pm 10kV$  for human body model discharges.

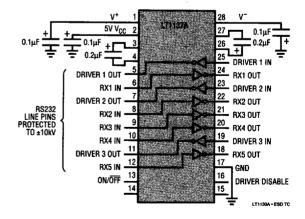
**RX IN:** Receiver Inputs. These pins accept RS232 level signals ( $\pm 30V$ ) into a protected 5k terminating resistor. The receiver inputs are protected against ESD to  $\pm 10kV$  for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity. Open receiver inputs assume a logic low state.

**RX OUT:** Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in SHUT-DOWN mode to allow data line sharing. Outputs are fully short-circuit protected to ground or  $V_{CC}$  with the power on, off, or in SHUTDOWN mode.

# **ESD PROTECTION**

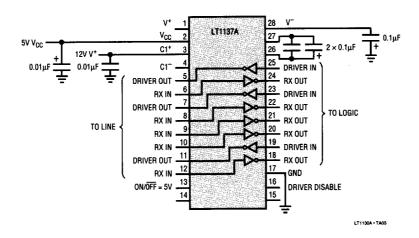
The RS232 line inputs of the LT1130A/LT1140A series of RS232 Driver/Receivers have on-chip protection from ESD transients up to  $\pm 10 kV$ . The protection structures act to divert the static discharge safely to system ground. In order for the ESD protection to function effectively, the power supply and ground pins of the LT1130A/LT1140A must be connected to ground through low impedances. The power supply decoupling capacitors and charge pump storage capacitors provide this low impedance in normal application of the circuit. The only constraint is that low ESR capacitors must be used for bypassing and charge storage. ESD testing must be done with pins  $V_{\rm CC}, V^+, V^-$  and GND shorted to ground or connected with low ESR capacitors.

#### **ESD Test Circuit**

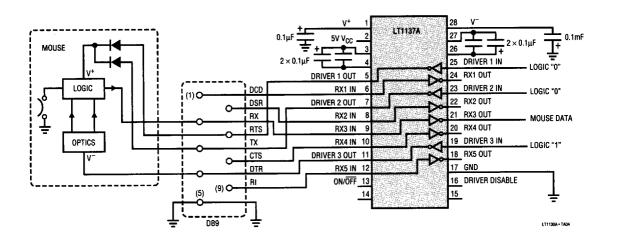


## TYPICAL APPLICATIONS

#### Operation Using 5V and 12V Power Supplies



#### **Typical Mouse Driving Application**





# TYPICAL APPLICATIONS

#### Sharing Power Supply Generator with a Second Transceiver

